### DISCRETE SEMICONDUCTORS

### DATA SHEET

### **BSS84**

# P-channel enhancement mode vertical D-MOS transistor

Product specification Supersedes data of 1995 Apr 07 File under Discrete Semiconductors, SC13b 1997 Jun 18





**BSS84** 

#### **FEATURES**

- · Low threshold voltage
- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown.

### **APPLICATIONS**

- Line current interrupter in telephone sets
- Relay, high speed and line transformer drivers.

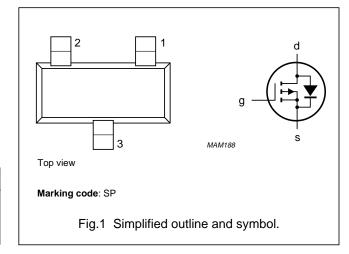
#### **DESCRIPTION**

P-channel enhancement mode vertical D-MOS transistor in a SOT23 SMD package.

CAUTION
The device is supplied in an antistatic package. The gate-source input must be protected against static discharge during transport or handling.

### **PINNING - SOT23**

PIN	SYMBOL	DESCRIPTION
1	g	gate
2	S	source
3	d	drain



#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>DS</sub>	drain-source voltage (DC)		_	-50	V
$V_{GSO}$	gate-source voltage (DC)	open drain	_	±20	V
$V_{GSth}$	gate-source threshold voltage	$I_D = -1 \text{ mA}; V_{DS} = V_{GS}$	-0.8	-2	V
I <sub>D</sub>	drain current (DC)		_	-130	mA
R <sub>DSon</sub>	drain-source on-state resistance	$I_D = -130 \text{ mA}; V_{GS} = -10 \text{ V}$	_	10	Ω
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	_	250	mW

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#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>DS</sub>	drain-source voltage (DC)		_	-50	V
V <sub>GSO</sub>	gate-source voltage (DC)	open drain	_	±20	V
$I_D$	drain current (DC)		_	-130	mA
I <sub>DM</sub>	peak drain current		_	-520	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	250	mW
T <sub>stg</sub>	storage temperature		<b>–65</b>	+150	°C
Tj	operating junction temperature		_	150	°C

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	500	K/W

### Note to the Limiting values and Thermal characteristics

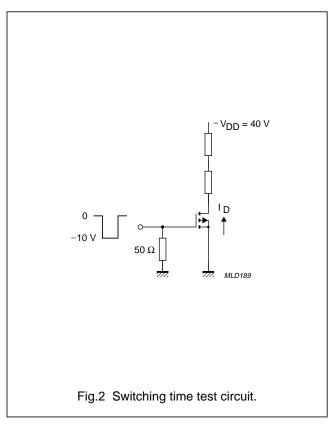
1. Device mounted on a printed-circuit board.

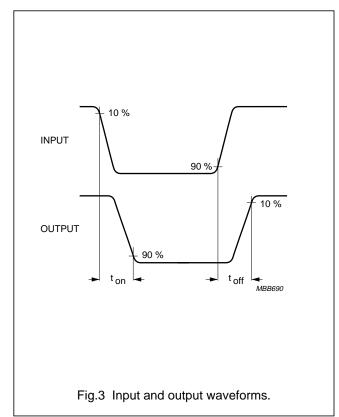
#### **CHARACTERISTICS**

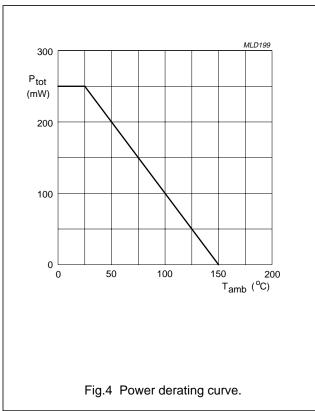
 $T_j$  = 25 °C unless otherwise specified.

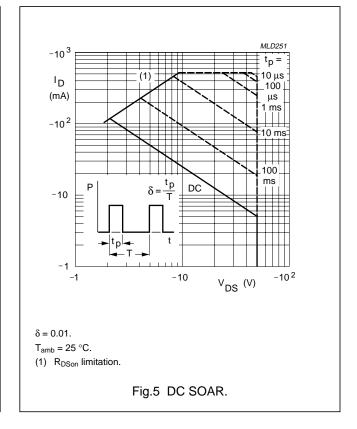
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0; I_D = -10 \mu A$	-50	_	_	V
$V_{GSth}$	gate-source threshold voltage	$V_{DS} = V_{GS}$ ; $I_D = -1 \text{ mA}$	-0.8	_	-2	V
I <sub>DSS</sub>	drain-source leakage current	$V_{GS} = 0; V_{DS} = -40 \text{ V}$	_	_	-100	nA
		$V_{GS} = 0; V_{DS} = -50 \text{ V}$	_	_	-10	μΑ
		$V_{GS} = 0$ ; $V_{DS} = -50 \text{ V}$ ; $T_j = 125 ^{\circ}\text{C}$	_	_	-60	μΑ
I <sub>GSS</sub>	gate leakage current	$V_{DS} = 0; V_{GS} = \pm 20 \text{ V}$	_	_	±10	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = -10 \text{ V}; I_D = -130 \text{ mA}$	_	_	10	Ω
y <sub>fs</sub>	forward transfer admittance	$V_{DS} = -25 \text{ V}; I_D = -130 \text{ mA}$	50	_	_	mS
C <sub>iss</sub>	input capacitance	$V_{GS} = 0$ ; $V_{DS} = -25 \text{ V}$ ; $f = 1 \text{ MHz}$	_	25	45	pF
C <sub>oss</sub>	output capacitance	$V_{GS} = 0$ ; $V_{DS} = -25 \text{ V}$ ; $f = 1 \text{ MHz}$	_	15	25	pF
C <sub>rss</sub>	reverse transfer capacitance	$V_{GS} = 0$ ; $V_{DS} = -25 \text{ V}$ ; $f = 1 \text{ MHz}$	_	3.5	12	pF
Switching times (see Figs 2 and 3)						
t <sub>on</sub>	turn-on time	$V_{GS} = 0 \text{ to } -10 \text{ V}; V_{DD} = -40 \text{ V};$ $I_D = -200 \text{ mA}$	_	3	_	ns
t <sub>off</sub>	turn-off time	$V_{GS} = -10 \text{ to } 0 \text{ V}; V_{DD} = -40 \text{ V};$ $I_D = -200 \text{ mA}$	_	7	_	ns

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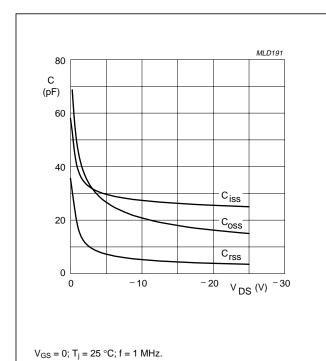
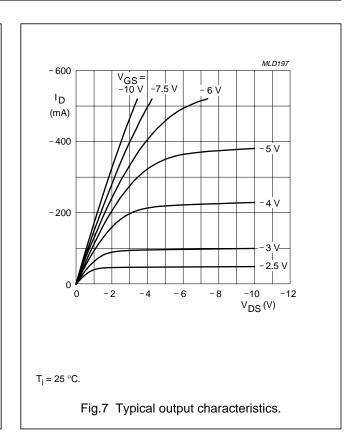
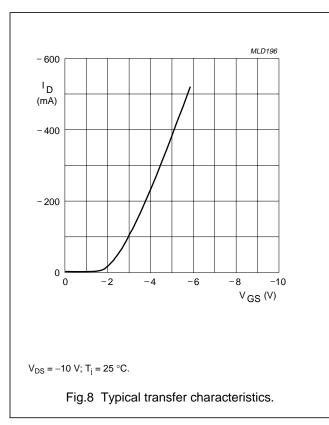
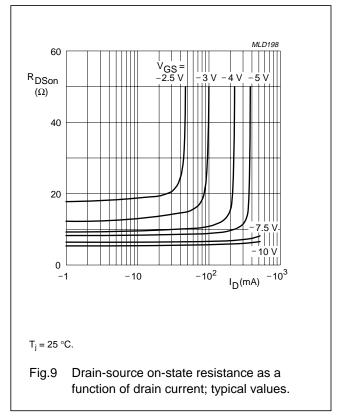


Fig.6 Capacitance as a function of drain source voltage; typical values.

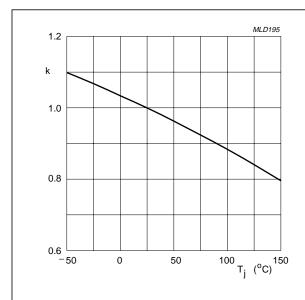






### P-channel enhancement mode vertical D-MOS transistor

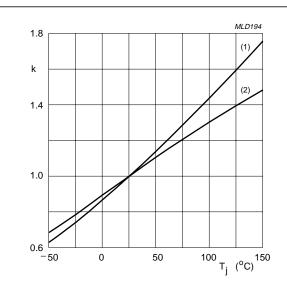
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$$k \, = \, \frac{V_{GSth} \, \, at \, \, T_j}{V_{GSth} \, \, at \, \, 25^{\circ}C}$$

 $I_D = -1 \text{ mA}$ ;  $V_{DS} = V_{GS}$ .

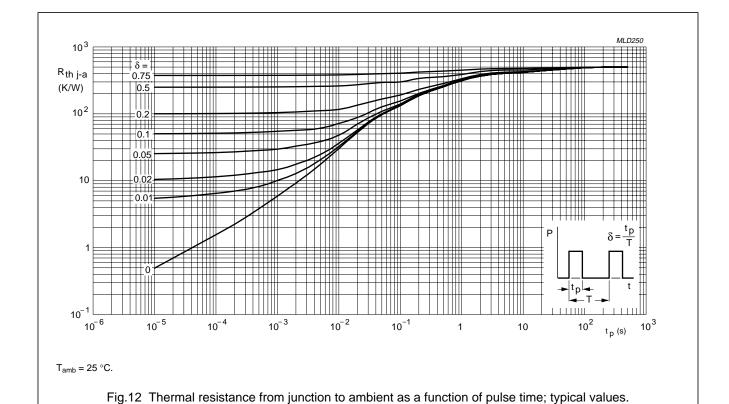
Fig.10 Temperature coefficient of gate-source threshold voltage.



$$k = \frac{R_{DSon} \text{ at } T_j}{R_{DSon} \text{ at } 25 \text{ }^{\circ}\text{C}}$$

- (1)  $I_D = -130 \text{ mA}$ ;  $V_{GS} = -10 \text{ V}$ .
- (2)  $I_D = -20 \text{ mA}$ ;  $V_{GS} = -2.4 \text{ V}$ .

Fig.11 Temperature coefficient of drain-source on-state resistance.

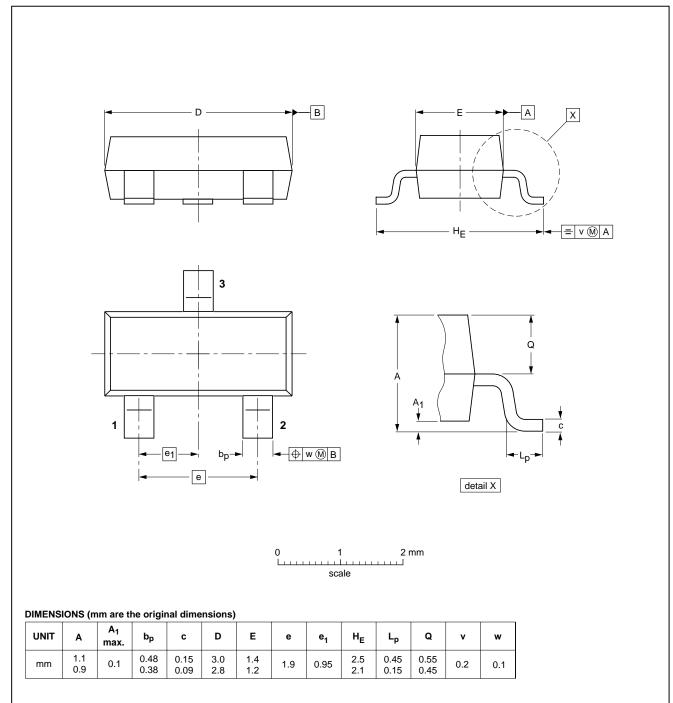


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#### **PACKAGE OUTLINE**

### Plastic surface mounted package; 3 leads

SOT23



**REFERENCES** 

EIAJ

**JEDEC** 

**EUROPEAN** 

**PROJECTION** 

**ISSUE DATE** 

97-02-28

1997 Jun 18	7
1997 IIIn 18	,

IEC

OUTLINE

VERSION

SOT23

### P-channel enhancement mode vertical D-MOS transistor

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#### **DEFINITIONS**

Data Sheet Status		
Objective specification	This data sheet contains target or goal specifications for product development.	
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.	
Product specification	This data sheet contains final product specifications.	
Limiting values		
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation		

more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

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### **NOTES**

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